

# **FMP07N60S1**

**FUJI POWER MOSFET** 

# **Super J-MOS series**

# N-Channel enhancement mode power MOSFET

#### Features

Low on-state resistance Low switching loss easy to use (more controllabe switching dV/dt by Rg)

# ■ Applications

**UPS** 

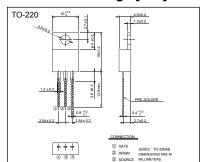
Server

Telecom

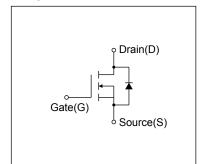
Power conditioner system

Power supply

# ■ Outline Drawings [mm]



# **■** Equivalent circuit schematic



### ■ Absolute Maximum Ratings at T<sub>c</sub>=25°C (unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks
Drain Source Voltage	V <sub>DS</sub>	600	V	
Drain-Source Voltage	V <sub>DSX</sub>	600	V	V <sub>GS</sub> =-30V
Continuous Drain Current	lo	±6.5	Α	Tc=25°C Note*1
Continuous Drain Current		±4.1	Α	Tc=100°C Note*1
Pulsed Drain Current	I <sub>DP</sub>	±19.5	Α	
Gate-Source Voltage	V <sub>GS</sub>	±30	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	lar	2.3	А	Note *2
Non-Repetitive Maximum Avalanche Energy	Eas	203.4	mJ	Note *3
Maximum Drain-Source dV/dt	dV⊳s/dt	50	kV/μs	V <sub>DS</sub> ≤ 600V
Peak Diode Recovery dV/dt	dV/dt	15	kV/μs	Note *4
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note *5
Maximum Davian Disabation	P₀	2.02	10/	T <sub>a</sub> =25°C
Maximum Power Dissipation		60	W	Tc=25°C
One metion and Steman Town and the many	T <sub>ch</sub>	150	°C	
Operating and Storage Temperature range	T <sub>stg</sub>	-55 to +150	°C	

#### ■ Electrical Characteristics at T<sub>c</sub>=25°C (unless otherwise specified) Static Ratings

Description	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	I <sub>D</sub> =250μA V <sub>GS</sub> =0V		600	-	-	V
Gate Threshold Voltage	V <sub>GS(th)</sub>	I <sub>D</sub> =250µA V <sub>DS</sub> =V <sub>GS</sub>		2.5	3.0	3.5	V
Zero Gate Voltage Drain Current	Ibss	V <sub>DS</sub> =600V V <sub>GS</sub> =0V	T <sub>ch</sub> =25°C	-	-	25	μА
		V <sub>DS</sub> =480V V <sub>GS</sub> =0V	T <sub>ch</sub> =125°C	-	-	250	
Gate-Source Leakage Current	Igss	V <sub>GS</sub> = ± 30V V <sub>DS</sub> =0V		-	10	100	nA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	I <sub>D</sub> =3.25A V <sub>GS</sub> =10V		-	0.49	0.58	Ω
Gate resistance	R <sub>G</sub>	f=1MHz, open drain		-	3.4	-	Ω

Note \*1 : Limited by maximum channel temperature.

Note \*2 : Tch≤150°C, See Fig.1 and Fig.2

Note \*3 : Starting Tch=25°C, I<sub>A</sub>s=1.4A, L=190mH, V<sub>DD</sub>=60V, R<sub>G</sub>=50Ω, See Fig.1 and Fig.2

Eas limited by maximum channel temperature and avalanche current. Note \*4 : Ir≤-Ip, -di/dt=100A/µs, Vpp≤400V, Vpeak≤BVpss, Tch≤150°C.

Note \*5 : IF $\leq$ -ID, dV/dt=15kV/ $\mu$ s, VDD $\leq$ 400V, Vpeak $\leq$ BVDSS, Tch $\leq$ 150°C.

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# Dynamic Ratings

Description	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	<b>g</b> fs	I <sub>D</sub> =3.25A V <sub>DS</sub> =25V	3	6	-	S
Input Capacitance	Ciss	V <sub>ps</sub> =10V	-	510	-	
Output Capacitance	Coss	V <sub>GS</sub> =0V	-	1130	-	
Reverse Transfer Capacitance	Crss	f=1MHz	-	100	-	
Effective output capacitance, energy related (Note *6)	C <sub>o(er)</sub>	V <sub>s</sub> =0V V <sub>b</sub> =0480V	-	43	-	pF
Effective output capacitance, time related (Note *7)	C <sub>o(tr)</sub>	V <sub>GS</sub> =0V V <sub>DS</sub> =0480V ID=constant	-	120	-	
Turn On Time	t <sub>d(on)</sub>	V <sub>DD</sub> =400V, V <sub>GS</sub> =10V/0V I <sub>D</sub> =3.25A, R <sub>G</sub> =36Ω See Fig.3 and Fig.4	-	9.5	-	
Turn-On Time	<b>t</b> r		-	28	-	ns
Turn-Off Time	t <sub>d(off)</sub>		-	73	-	
	<b>t</b> f		-	17.5	-	
Total Gate Charge	Q <sub>G</sub>	V <sub>DD</sub> =480V, I <sub>D</sub> =6.5A V <sub>GS</sub> =10V See Fig.5	-	21	-	
Gate-Source Charge	Q <sub>GS</sub>		-	7	-	]
Gate-Drain Charge	Q <sub>GD</sub>		-	4.5	-	nC
Drain-Source crossover Charge	Qsw		-	4.5	-	

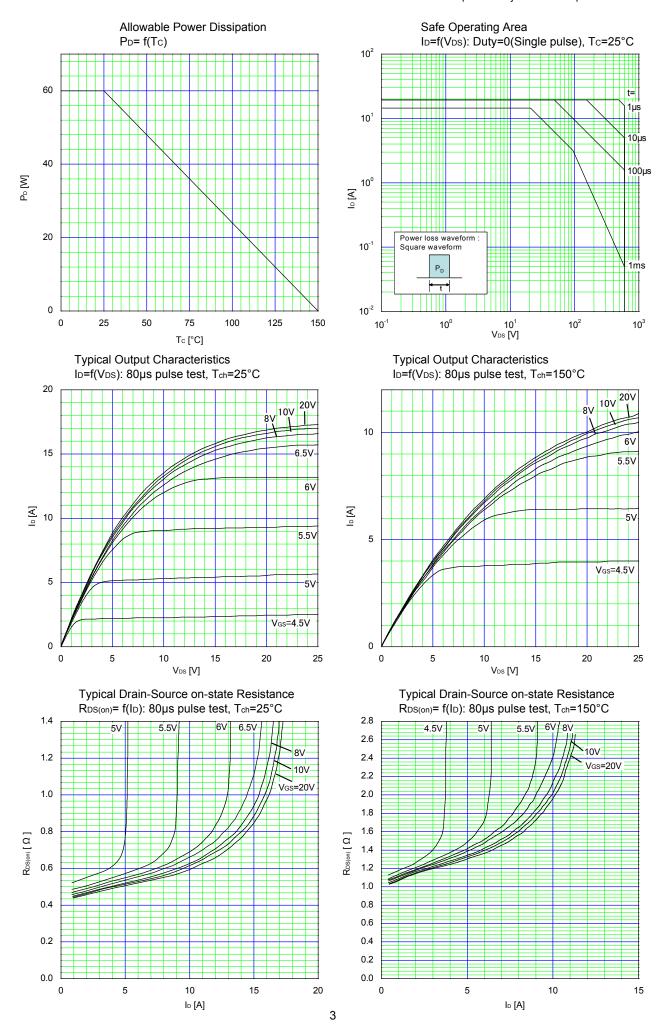
Note \*6 :  $C_{\text{o(er)}}$  is a fixed capacitance that gives the same stored energy as  $C_{\text{oss}}$  while  $V_{\text{DS}}$  is rising from 0 to 80% BVoss. Note \*7 :  $C_{\text{o(er)}}$  is a fixed capacitance that gives the same charging times as  $C_{\text{oss}}$  while  $V_{\text{DS}}$  is rising from 0 to 80% BVoss.

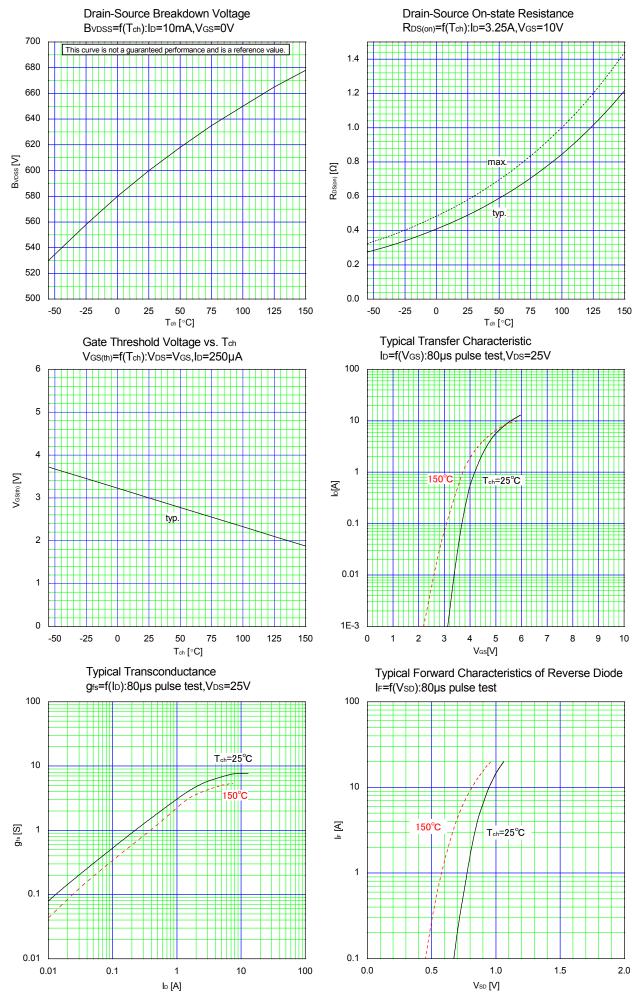
# • Reverse Diode

Description	Symbol	Conditions	min.	typ.	max.	Unit
Avalanche Capability	lav	L=42.9mH, T <sub>ch</sub> =25°C See Fig.1 and Fig.2	2.3	-	-	Α
Diode Forward On-Voltage	V <sub>SD</sub>	I <sub>F</sub> =6.5A, V <sub>GS</sub> =0V T <sub>ch</sub> =25°C	-	0.9	1.35	V
Reverse Recovery Time	trr	$I_{\text{F}}\text{=}6.5\text{A},  V_{\text{DD}}\text{=}400\text{V} \\ -\text{di/dt}\text{=}100\text{A}/\mu\text{s} \\ V_{\text{CS(C1)}}\text{=}\text{short},  V_{\text{CS(C2)}}\text{=}10\text{V/0V} \\ R_{\text{G}}\text{=}300\Omega \\ T_{\text{ch}}\text{=}25^{\circ}\text{C} \\ \text{See Fig.6 and Fig.7}$		275	-	ns
Reverse Recovery Charge	Qrr		-	2.7	-	μC
Peak Reverse Recovery Current	I <sub>rp</sub>		-	18	-	Α

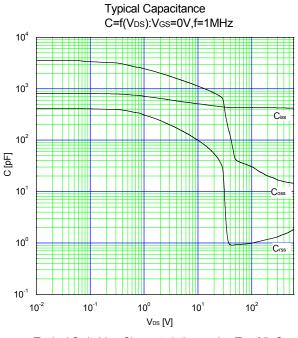
# ■ Thermal Resistance

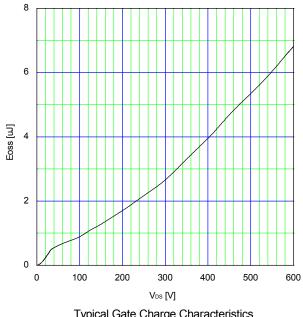
Parameter	Symbol	min.	typ.	max.	Unit
Channel to Case	R <sub>th(ch-c)</sub>	-	-	2.08	°C/W
Channel to Ambient	R <sub>th(ch-a)</sub>	-	-	62	°C/W



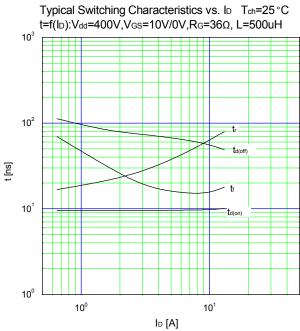


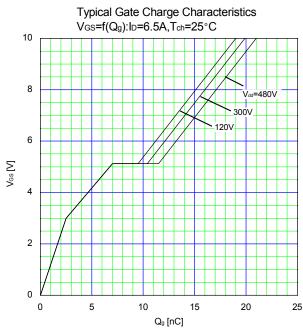
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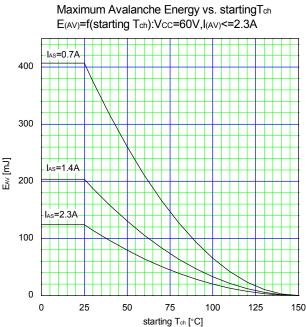


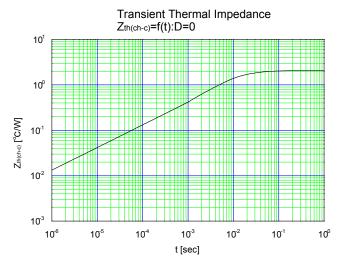


Typical Coss stored energy









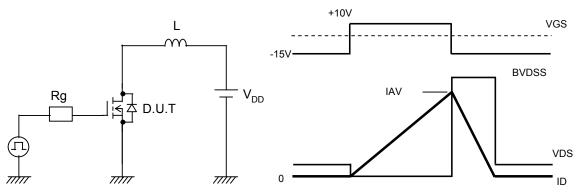


Fig.1 Avalanche Test circuit

Fig.2 Operating waveforms of Avalanche Test

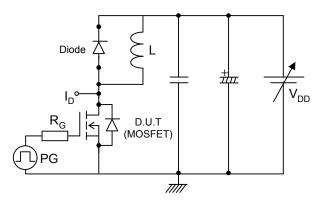


Fig.3 Switching Test circuit

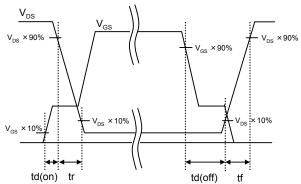


Fig.4 Operating waveform of Switching Test

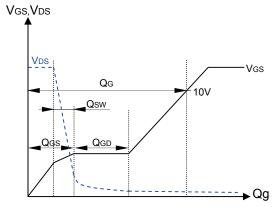


Fig.5 Operating waveform of Gate charge Test

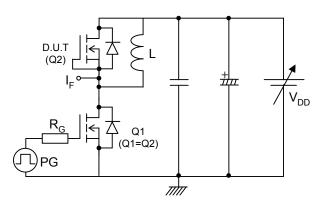


Fig.6 Reverse recovery Test circuit

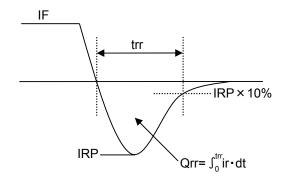
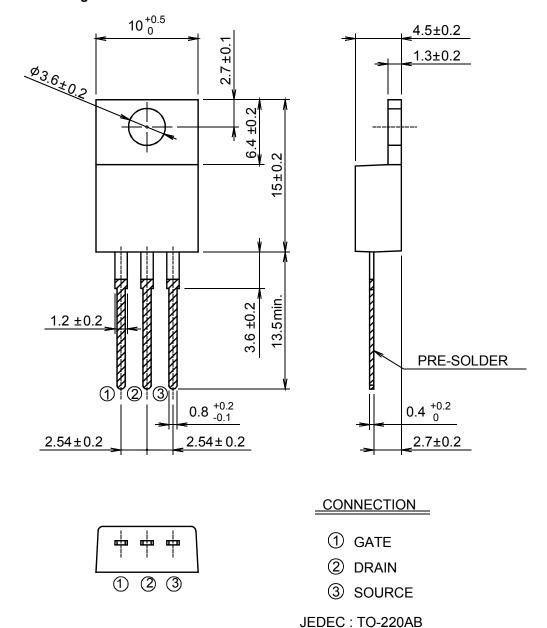
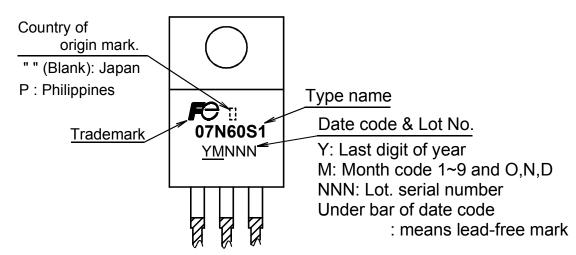


Fig.7 Operating waveform of Reverse recovery Test

# ■ Outview: TO-220 Package



# ■ Marking



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